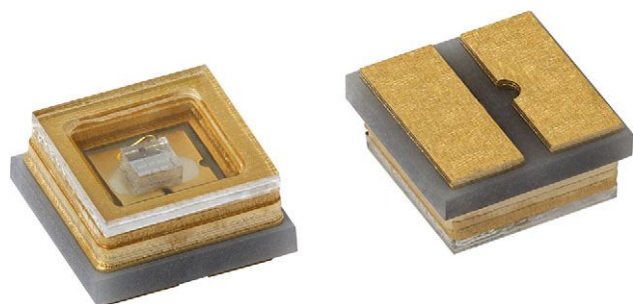


## UVC Emitting Diode in SMD Package



### DESCRIPTION

VLMU35CR4x-275-120 is a high efficiency UVC LED series with focus on maximum mW/\$.

The package size is 3.45 mm x 3.45 mm x 1.7 mm and the radiant power is typically 37 mW at 250 mA in a wavelength range of 265 nm to 280 nm, highly suitable for sterilization applications. The thermally optimized package technology with ceramic substrate and a quartz window, ensures a long service life.

### PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD ceramic
- Product series: standard power UV LED
- Angle of half intensity:  $\pm 60^\circ$
- Lead-finishing: Au

### FEATURES

- Ceramic SMT package with quartz window
- Dimension (L x W x H) in mm: 3.45 x 3.45 x 1.7
- DC forward current: up to 300 mA
- Radiant power (typ.): 37 mW at 250 mA and 30 mW at 190 mA
- Leads / terminations finish: gold plated (Au)
- Reflow soldering method
- MSL 3 according to J-STD-020
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### APPLICATIONS

- Sterilization - water, air, and surfaces
- Medical application
- Sensing of gases, germs, DNA, ...

### SAFETY ADVICES

These LEDs emit very strong UV radiation during operation. Do not look directly into the LED light when in operation as UV radiation can harm your eyes. To prevent inadequate exposure, wear protective eyewear. If LEDs are embedded in devices, please indicate warning labels. Avoid exposure to skin or other tissue during operation. Keep out of the reach of children. Take appropriate precautions around pets and other living organisms to avoid UV exposure.

### PARTS TABLE

PART	COLOR	RADIANT POWER (mW)			at $I_F$ (mA)	WAVELENGTH (nm)			at $I_F$ (mA)	FORWARD VOLTAGE (V)			at $I_F$ (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMU35CR40-275-120	Ultraviolet	27.5	37	-	250	265	274	280	250	5.2	6.5	7.7	250	AlGaIn
VLMU35CR41-275-120	Ultraviolet	30	37	-	250	265	274	280	250	5.2	6.5	7.7	250	AlGaIn

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^\circ\text{C}$ , unless otherwise specified) VLMU35CR40-275-120, VLMU35CR41-275-120

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
DC forward current		$I_F$	300	mA
Power dissipation		$P_V$	2.31	W
Reverse voltage			Not designed for reverse operation	
Electrostatic discharge	HBM: MIL-STD-883 C 3B	ESD	2000	V
Junction temperature		$T_j$	+105	$^\circ\text{C}$
Operating temperature range		$T_{amb}$	-40 to +80	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-40 to +100	$^\circ\text{C}$
Solder temperature		$T_{sol}$	260	$^\circ\text{C}$

**OPTICAL AND ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)  
**VLMU35CR40-275-120, VLMU35CR41-275-120, ULTRAVIOLET**

PARAMETER	TEST CONDITION	PARTS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 250\text{ mA}$	VLMU35CR40-275-120	$V_F$	5.2	6.5	7.7	V
		VLMU35CR41-275-120		5.2	6.5	7.7	
Radiant power	$I_F = 190\text{ mA}$		$\phi_e$	-	30	-	mW
	$I_F = 250\text{ mA}$	VLMU35CR40-275-120		27.5	37	-	
		VLMU35CR41-275-120		30	37	-	
Ratio of radiant intensity / radiant power	$I_F = 250\text{ mA}$		$I_e/\phi_e$	-	0.27	-	$\text{sr}^{-1}$
Peak wavelength	$I_F = 250\text{ mA}$		$\lambda_p$	265	274	280	nm
Angle of half intensity	$I_F = 250\text{ mA}$		$\phi$	-	$\pm 60$	-	$^{\circ}$
Thermal resistance junction to solder-point	Soldered on 20 x 20 x 1.7 (in mm) Al MCPCB		$R_{thJS}$	-	17	-	K/W

**Note**

- Tolerances:  $\pm 11\%$  for  $\phi_e$ ,  $\pm 0.1\text{ V}$  for  $V_F$ ,  $\pm 3\text{ nm}$  for  $\lambda_p$

**RADIANT POWER CLASSIFICATION** ( $I_F = 250\text{ mA}$ )

GROUP	MIN.	MAX.	UNIT
P1	27.5	30	mW
P2	30	35	
P3	35	40	
P4	40	45	

**PEAK WAVELENGTH CLASSIFICATION** ( $I_F = 250\text{ mA}$ )

GROUP	MIN.	MAX.	UNIT
W1	265	280	nm

**FORWARD VOLTAGE CLASSIFICATION** ( $I_F = 250\text{ mA}$ )

GROUP	MIN.	MAX.	UNIT
VZ	5.2	5.7	V
V0	5.7	6.2	
V1	6.2	6.7	
V2	6.7	7.2	
V3	7.2	7.7	

**Note**

- In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for radiant intensity, wavelength, and forward voltage will be shipped in any one reel

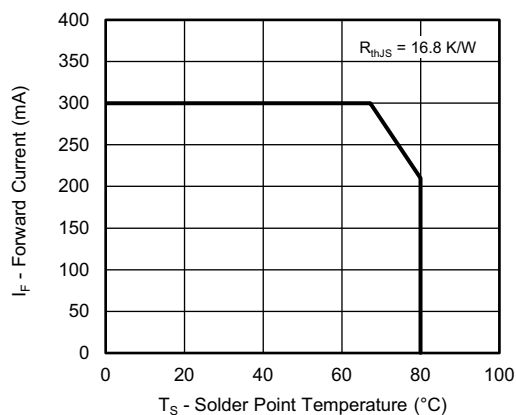
**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - Maximum Forward Current vs. Solder Point Temperature

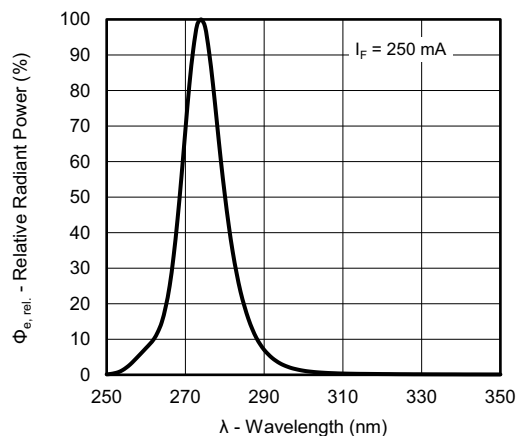


Fig. 4 - Relative Radiant Power vs. Wavelength

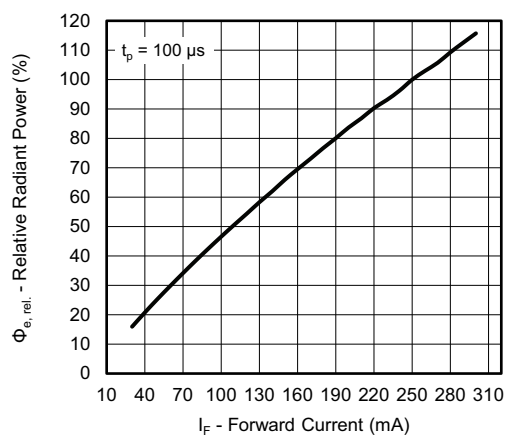


Fig. 2 - Relative Radiant Power vs. Forward Current

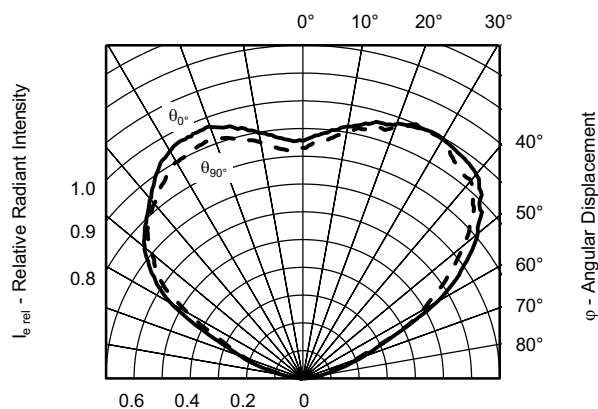


Fig. 5 - Relative Radiant Intensity vs. Angular Displacement

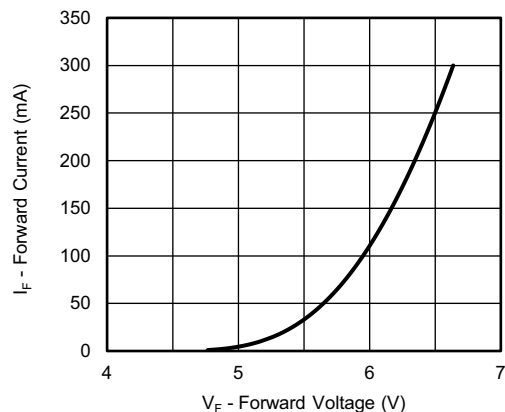


Fig. 3 - Forward Current vs. Forward Voltage

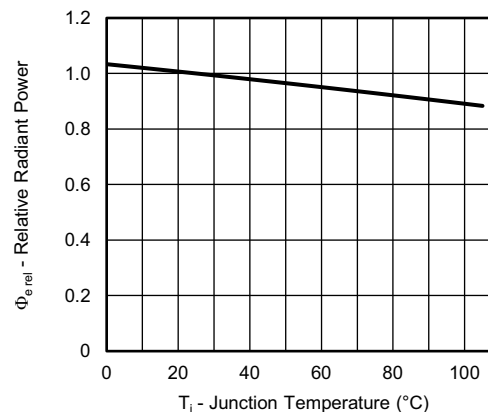


Fig. 6 - Relative Radiant Power vs. Junction Temperature

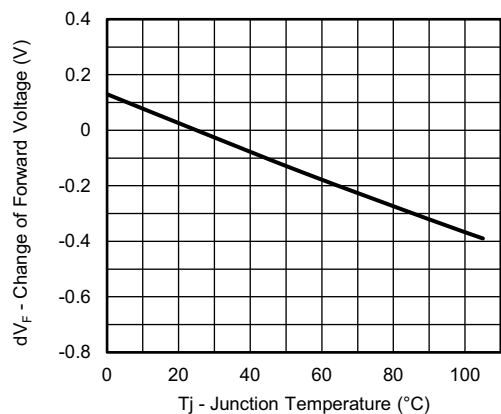
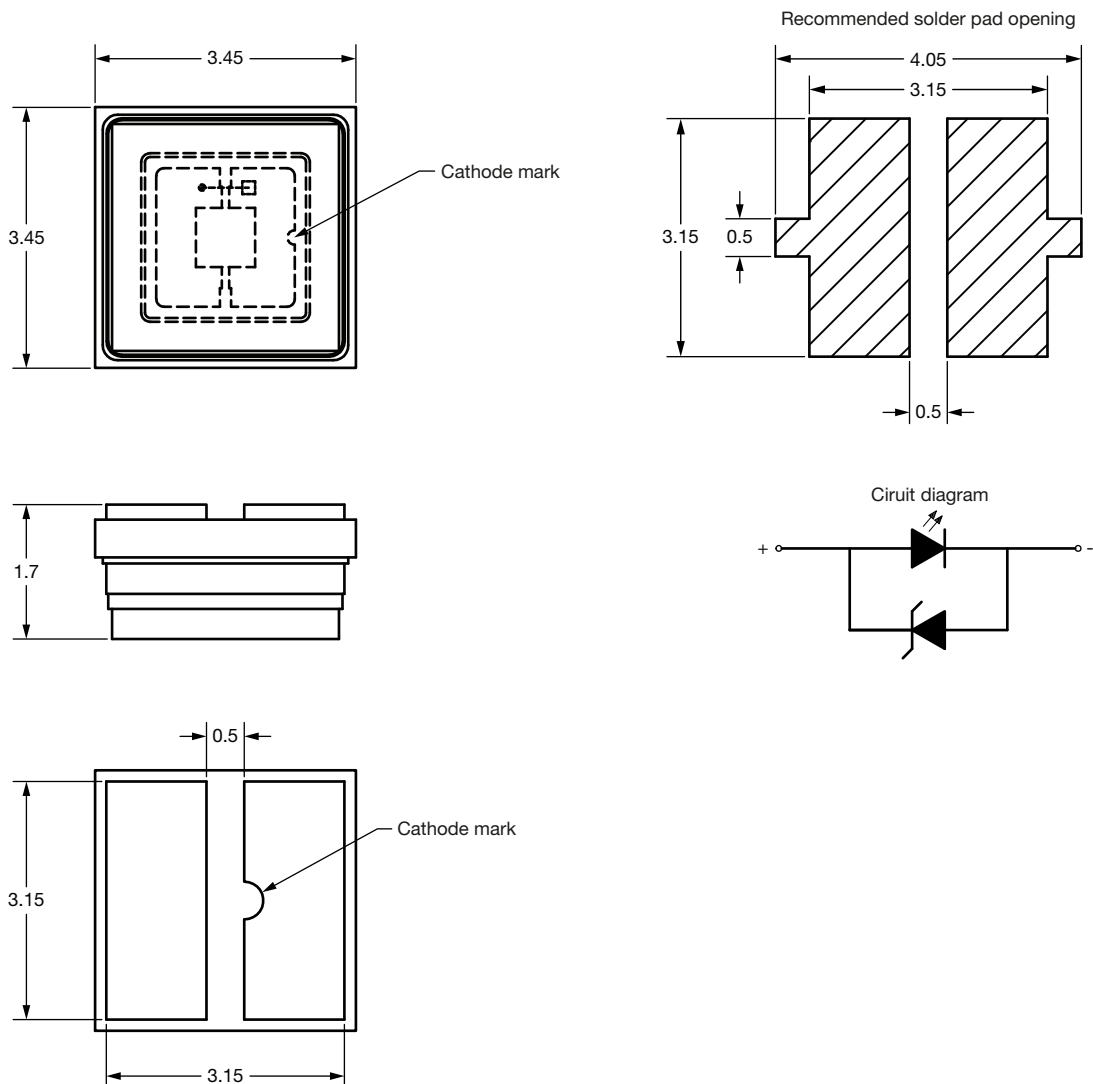


Fig. 7 - Change of Forward Voltage vs. Junction Temperature

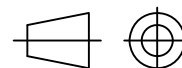
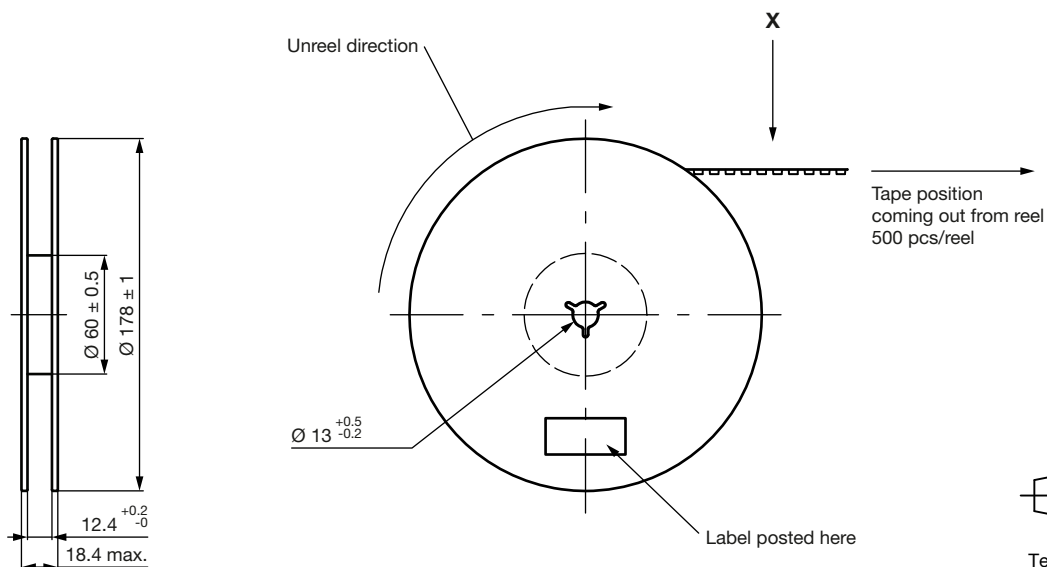
## PACKAGE DIMENSIONS in millimeters





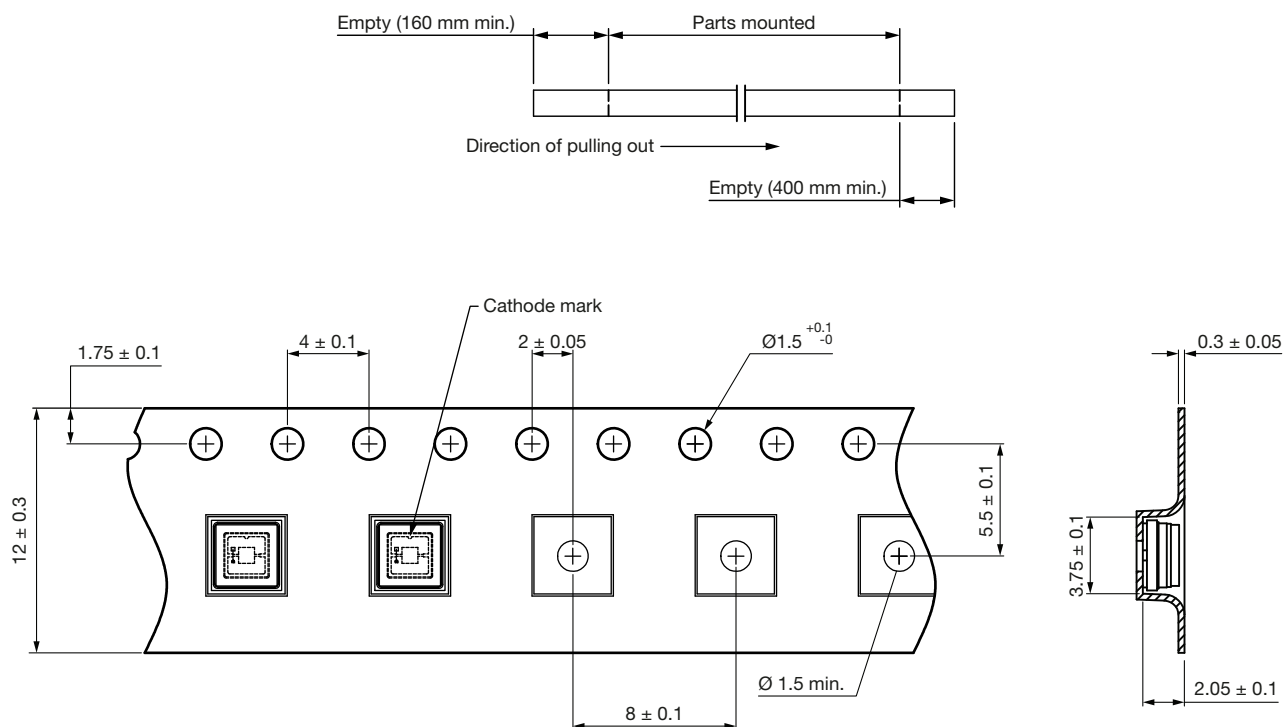
## TAPE AND REEL DIMENSIONS in millimeters

### Reel



Technical drawings  
according to DIN  
specification

### Leader and trailer tape



## SOLDERING PROFILE

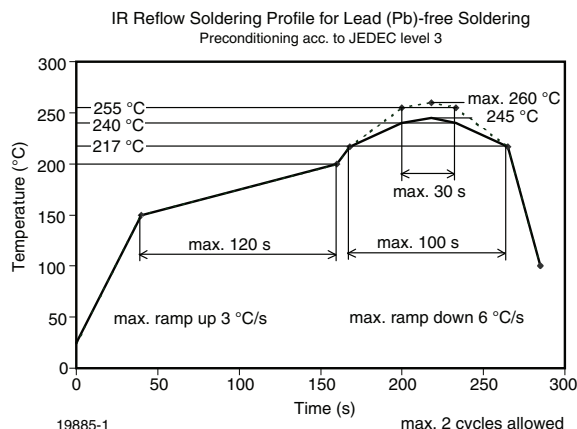
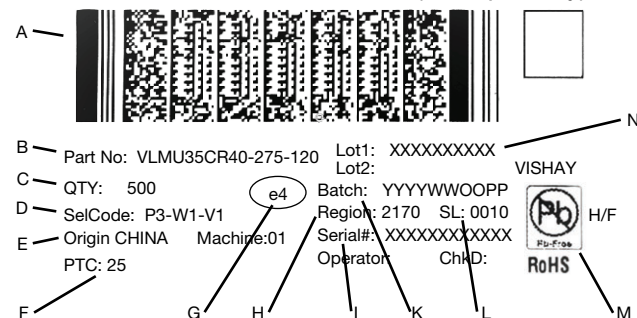


Fig. 8 - Vishay Lead (Pb)-free Reflow Soldering Profile  
(according to J-STD-020C)

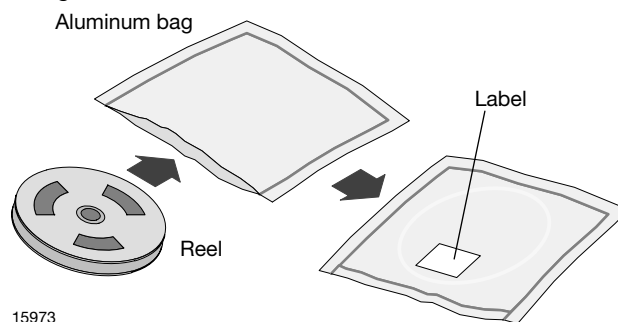
## BAR CODE PRODUCT LABEL (example only)



- A. 2D barcode
- B. Part No: Vishay part number
- C. QTY: quantity
- d. SelCode: selection bin code:  $I_V - \lambda_p - V_F$
- E. Country of origin
- F. PTC: production plant code
- G. Termination finish
- H. Region code
- I. Serial#: serial number
- K. Batch number: year, week, country code, plant code
- L. SL: sales location
- M. Environmental symbols:  
RoHS, lead (Pb)-free, halogen-free
- N. Lot numbers

## DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



## FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

## RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

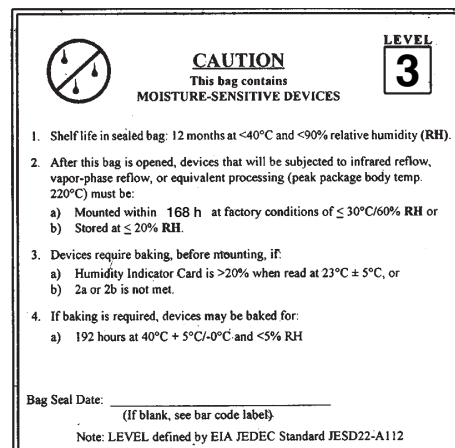
- Storage temperature 10 °C to 30 °C
- Storage humidity  $\leq 60\%$  RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

- 192 h at 40 °C + 5 °C / - 0 °C and  $< 5\%$  RH (dry air / nitrogen) or
- 24 h at 60 °C + 5 °C and  $< 5\%$  RH for all device containers or
- 24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 3 label is included on all dry bags.



17028-2



**ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

**VISHAY SEMICONDUCTORS STANDARD  
BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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